

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT8145097

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MEHMET SENCAN	08/07/2023
RECEIVING PARTY DATA	
Name:	INTEGRATED MEDICAL SENSORS
Street Address:	30 HUGHES
Internal Address:	SUITE 200
City:	IRVINE
State/Country:	CALIFORNIA
Postal Code:	92618
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	18093532
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	5133146021
Email:	jheithaus@gmail.com
Correspondent Name:	JOHN HEITHAUS
Address Line 1:	5401 KENOSHA LANE
Address Line 4:	IRVINE, CALIFORNIA 92603
ATTORNEY DOCKET NUMBER:	003-US2
NAME OF SUBMITTER:	JOHN HEITHAUS
SIGNATURE:	/John Heithaus/
DATE SIGNED:	09/01/2023
Total Attachments: 2	
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PATENT ASSIGNMENT

Docket Number: 003-US2

Application Number: 18/093,532

WHEREAS, I, Mehmet Sencan of Tustin, California, have invented the Wired Implantable Monolithic Integrated Sensor Circuit described in the patent application filed on January 5, 2023, in the United States of America, being owner of and having the right to convey all rights, title, and interests in and to said application and in and to each invention described therein; and


WHEREAS, Integrated Medical Sensors of Irvine, California, a corporation organized under the laws of the state of Delaware and having a mailing address of 30 Hughes, Suite 200 in Irvine, California (assignee) desires to acquire the entire right, title, and interest in and to said application and said invention described therein and any and all patents to be obtained therefor, all as herein after set forth:

NOW, THEREFORE, for good and valuable consideration received by the undersigned, the undersigned hereby sells, assigns, transfers and sets over unto said assignee, its successors and assigns, the entire right, title and interest in and to said invention or inventions, as described in said application, in all forms and embodiments thereof, and in and to the aforesaid application; and in and to any application filed in any foreign country based thereon, including the right to file said foreign applications under the International Convention; also the entire right, title and interest in and to any and all patents or reissues or extensions thereof to be obtained in this or any foreign country upon said invention or inventions and any non-provisional, utility, design, divisional, continuation, continuation-in-part or substitute applications which may be filed upon said invention or invention in this or any foreign country; and the undersigned hereby authorized and requests the issuing authority to issue any and all patents on said application or applications to said assignee or its successors and assigns.

The undersigned further agrees to execute and deliver all non-provisional, utility, design, continuing, substitute, improvement, extension, reissue and other patent applications in this or any foreign country relating to said application or invention and to sign all other lawful papers and to perform all other lawful acts without further consideration, subject to reimbursement of out-of-pocket expenses approved by assignee in advance in writing, which the assignee may deem necessary or desirable to make this Assignment fully effective, including by way of example, but not of limitation, the following acts:

- 1) Prompt execution of all lawful oaths, affidavits and/or supplemental oaths required or deemed advisable by the assignee to further the prosecution of any application or applications for letters patent relating to the subject matter of this Assignment; and
- 2) Cooperation to the best of my ability in the execution of all lawful documents, the production of evidence, and the giving of testimony in interference, opposition, nullification or infringement proceedings involving any of said invention or improvement, applications or patents.

IN WITNESS WHEREOF, the undersigned has hereunto set his/her hand and seal on the date set after his signature.

 08/27/2023

Mehmet Sencan